	Application No.	Applicant(s)	Applicant(s)  DLUGOKECKI ET AL.	
	10/041,720	DLUGOKECKI ET		
Notice of Allowability	Examiner	Art Unit		
	Alonzo Chambliss	2814	grad .	
The MAILING DATE of this communication app All claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85 NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT F of the Office or upon petition by the applicant. See 37 CFR 1.31	S (OR REMAINS) CLOSED in 5) or other appropriate commun RIGHTS. This application is su	this application. If not including a specific the contraction will be mailed in due	ded e course. <b>THIS</b>	
1. This communication is responsive to <u>11/1/04</u> .				
2. The allowed claim(s) is/are 2-22.				
3. 🖾 The drawings filed on <u>07 January 2002</u> are accepted by the	he Examiner.			
<ul> <li>4. ☐ Acknowledgment is made of a claim for foreign priority of a) ☐ All b) ☐ Some* c) ☐ None of the:</li> <li>1. ☐ Certified copies of the priority documents have:</li> <li>2. ☐ Certified copies of the priority documents have:</li> <li>3. ☐ Copies of the certified copies of the priority documents have:</li> <li>International Bureau (PCT Rule 17.2(a)).</li> <li>* Certified copies not received:</li> </ul>	re been received. re been received in Application	n No	ation from the	
Applicant has THREE MONTHS FROM THE "MAILING DATE" noted below. Failure to timely comply will result in ABANDONI THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.	' of this communication to file a MENT of this application.	a reply complying with the re	equirements	
<ol> <li>A SUBSTITUTE OATH OR DECLARATION must be subm INFORMAL PATENT APPLICATION (PTO-152) which given</li> </ol>	nitted. Note the attached EXAI res reason(s) why the oath or	MINER'S AMENDMENT or declaration is deficient.	NOTICE OF	
6. CORRECTED DRAWINGS ( as "replacement sheets") mu	st be submitted.			
(a) ☐ including changes required by the Notice of Draftsper		(PTO-948) attached		
1)  hereto or 2)  to Paper No./Mail Date				
<ul><li>(b) ☐ including changes required by the attached Examiner Paper No./Mail Date</li></ul>	's Amendment / Comment or i	n the Office action of		
Identifying indicia such as the application number (see 37 CFR each sheet. Replacement sheet(s) should be labeled as such in	1.84(c)) should be written on the	e drawings in the front (not th	e back) of	
7. DEPOSIT OF and/or INFORMATION about the depo	<del>-</del> .	• •	Note the	
attached Examiner's comment regarding REQUIREMENT	FOR THE DEPOSIT OF BIOI	LOGICAL MATERIAL.	Note the	
Attachment(s)	5 <b></b>			
1. Notice of References Cited (PTO-892) 2. Notice of Proffperson's Refer t Province Review (PTO 049)		ormal Patent Application (PT	O-152)	
2. Notice of Draftperson's Patent Drawing Review (PTO-948)	Paper No./M	mmary (PTO-413), //ail Date		
<ol> <li>Information Disclosure Statements (PTO-1449 or PTO/SB/ Paper No./Mail Date</li> </ol>	08), 7. 🔲 Examiner's A	mendment/Comment		
4. Examiner's Comment Regarding Requirement for Deposit	8. 🛭 Examiner's S	Statement of Reasons for All	owance	
of Biological Material	9. 🗌 Other			
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## **DETAILED ACTION**

## Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 11/1/04 has been entered.

## Allowable Subject Matter

2. The following is a statement of reasons for the indication of allowance subject matter: the prior art of record does not teach or suggest the combination of a deconstructing an integrated circuit package for exposing a wire bond pad and a lead frame located. A die attached to a wire bond pad and encapsulating the die and the wire bond pad in encapsulant to form a first encapsulated package. A second encapsulated package encapsulated separately from the first encapsulant package. Reshaping the first encapsulated package and the second encapsulated package at the same time by using a lapping process, wherein the lapping process is performed using a planar abrasive surface sufficiently large to permit the first and second encapsulates to be lapped at the same time in claim 10.

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Any inquiry concerning the communication or earlier communications from the examiner should be directed to Alonzo Chambliss whose telephone number is (571) 272-1927.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the group receptionist whose telephone number is (703) 308-7956.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system Status information for published applications may be obtained from either Private PMR or Public PMR. Status information for unpublished applications is available through Private PMR only. For more information about the PMR system see http://pair-dkect.uspto.gov. Should you have questions on access to the Private PMR system contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free) or <a href="mailto:EBC\_Support@uspto.gov">EBC\_Support@uspto.gov</a>.

**AC/December 17, 2004** 

Alonzo Chambliss

**Primary Patent Examiner** 

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